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**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> max. (nC)

Configuration

## **Power MOSFET**

S

N-Channel MOSFET

0.93

650

48

12

19

Single

 $V_{GS} = 10 V$ 

### **FEATURES**

· Low gate charge Qg results in simple drive requirement



- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching

#### **TYPICAL SMPS TOPOLOGIES**

- Single transistor flyback
- · Single transistor forward

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFB9N65APbF
Lead (Pb)-free and halogen-free	IRFB9N65APbF-BE3

PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	650	N	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous durin coment	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		8.5		
Continuous drain current		T <sub>C</sub> = 100 °C	I <sub>D</sub>	5.4	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	21			
Linear derating factor			1.3	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	325	mJ		
Repetitive avalanche current <sup>a</sup>		I <sub>AR</sub>	5.2	А		
Repetitive avalanche energy <sup>a</sup>		E <sub>AR</sub>	16	mJ		
Maximum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		PD	167	W		
Peak diode recovery dV/dt <sup>c</sup>		dV/dt	2.8	V/ns		
Operating junction and storage temperature range	ating junction and storage temperature range T <sub>J</sub> , T <sub>stg</sub>		-55 to +150			
Soldering recommendations (peak temperature) <sup>d</sup>	For	10 s		300	- °C	
Mounting torque	6.00 or 1	10		10	lbf ∙ in	
Mounting torque	6-32 or M3 screw			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T<sub>J</sub> = 25 °C, L = 24 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.2 A (see fig. 12) c. I<sub>SD</sub>  $\leq$  5.2 A, dl/dt  $\leq$  90 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C

d. 1.6 mm from case

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## IRFB9N65A

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.75	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		650	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA <sup>d</sup>		-	670	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Zaus and unlike an elusia suurant		$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	μA
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 520 \	V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	250	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 5.1 \text{ A}^{\text{b}}$		-	-	0.93	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3.1 A		3.9	-	-	S
Dynamic						•	
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	1417	-	
Output capacitance	Coss		$V_{DS} = 25 V,$	-	177	-	1
Reverse transfer capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	7.0	-	
	C <sub>oss</sub>		V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	1912	-	- pF
Output capacitance		$V_{GS} = 0 V$	V <sub>DS</sub> = 520 V, f = 1.0 MHz	-	48	-	
Effective output capacitance	Coss eff.		$V_{DS}$ = 0 V to 520 V <sup>c</sup>	-	84	-	1
Total gate charge	Qg			-	-	48	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 5.2 A, V <sub>DS</sub> = 400 V see fig. 6 and 13 <sup>b</sup>	-	-	12	nC
Gate-drain charge	Q <sub>gd</sub>		see lig. o and to	-	-	19	1
Turn-on delay time	t <sub>d(on)</sub>		•	-	14	-	
Rise time	t <sub>r</sub>		= 325 V, I <sub>D</sub> = 5.2 A	-	20	-	ns
Turn-off delay time	t <sub>d(off)</sub>	n <sub>g</sub> =	9.1 $\Omega$ ,R <sub>D</sub> = 62 $\Omega$ , see fig. 10 <sup>b</sup>	-	34	-	
Fall time	t <sub>f</sub>		<b>3</b>	-	18	-	
Gate input resistance	Rg	f = 1	MHz, open drain	0.5	-	3.3	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	١ <sub>S</sub>	MOSFET s showing	the	-	-	5.2	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral re p - n junctio		-	-	21	A
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, $I_{\rm S}$ = 5.2 A, $V_{\rm GS}$ = 0 V <sup>b</sup>	-	-	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>			-	493	739	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_{\rm J} = 25 ^{\circ}{\rm C}, I_{\rm F}$	= 5.2 A, dl/dt = 100 A/µs <sup>b</sup>	-	2.1	3.2	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic tu	Irn-on time is negligible (turn	-on is dor	ninated b	vleand	<u> </u>

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

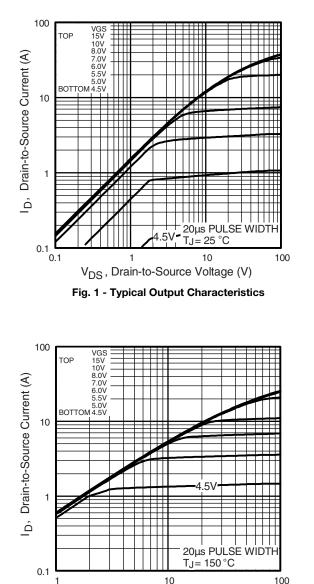
d. Uses SiHFIB5N65A data and test conditions

2 For technical questions, contact: <u>hvm@vishay.com</u>



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



V<sub>DS</sub>, Drain-to-Source Voltage (V) Fig. 2 - Typical Output Characteristics

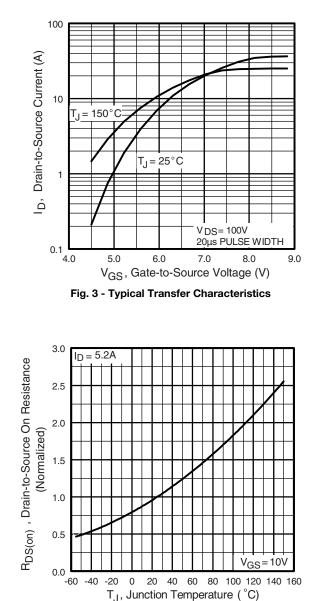


Fig. 4 - Normalized On-Resistance vs. Temperature



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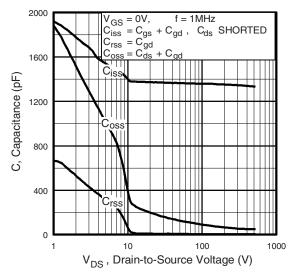


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

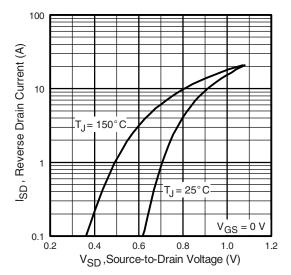


Fig. 7 - Typical Source-Drain Diode Forward Voltage

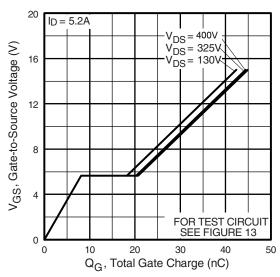


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

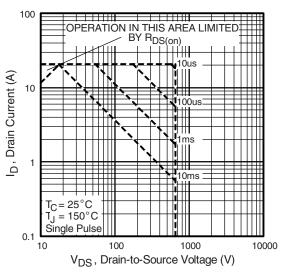


Fig. 8 - Maximum Safe Operating Area

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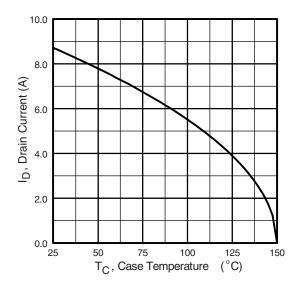


Fig. 9 - Maximum Drain Current vs. Case Temperature

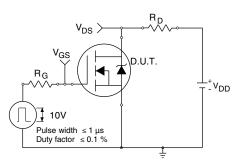


Fig. 10a - Switching Time Test Circuit

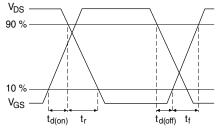
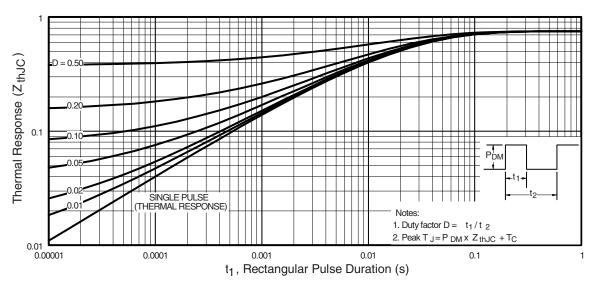


Fig. 10b - Switching Time Waveforms





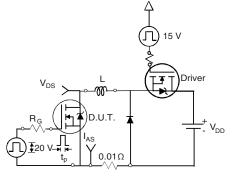


Fig. 12a - Unclamped Inductive Test Circuit

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Fig. 12b - Unclamped Inductive Waveforms

VDS

IAS



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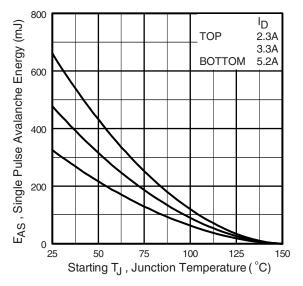
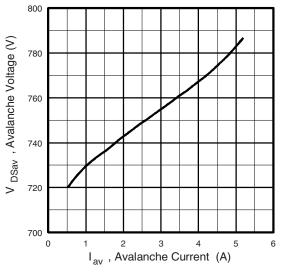
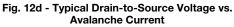


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





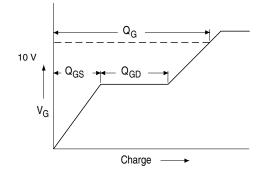


Fig. 13a - Basic Gate Charge Waveform

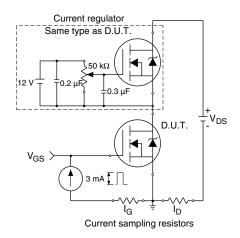
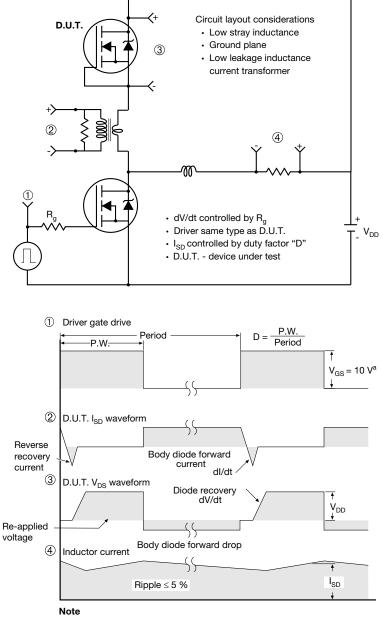


Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

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• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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